## H12DSi-N6



#### **Key Features**

- Dual AMD EPYC<sup>™</sup> 7003/7002 Series Processors
   (The latest AMD EPYC<sup>™</sup> 7003 Series Processor with AMD 3D V-Cache<sup>™</sup> Technology requires BIOS version 2.3 or newer)
- 2. 4TB Registered ECC DDR4 3200MHz SDRAM in 16 DIMMs
- 3. Expansion slots:

3 PCI-E 4.0 x16 slots, 3 PCI-E 4.0 x8 slots

**M.2 Interface**: 1 PCI-E 4.0 x4 **M.2 Form Factor**: 2280, 22110

M.2 Key: M-key

- 4. 10 SATA3, 2 SATADOM, 4 NVMe
- Dual Gigabit LAN ports,1 dedicated IPMI LAN Port
- 6. ASPEED AST2600 BMC graphics
- 7. 2 USB 2.0 ports (rear),
  - 4 USB 3.0 ports (2 rear, 2 headers)
- 8. 8x 4-pin PWM Fans & Speed control

Note: Image above may show a varied configuration of optional parts. Please refer to parts list for standard parts included.

#### Links & Resources

- Tested Memory List
- ▶ Tested HDD List
- Tested M.2 List
- Tested AOC List
- Motherboard Manual
- Update Your BIOS
- ▶ IPMI Firmware
- Download the Latest Drivers and Utilities
- Download Driver CD
- OS Compatibility



# **Specifications**

Product SKUs		Chassis ( Optimize	ed for H12DSi-N6)
MBD-H12DSi-N6	■ H12DSi-N6	2U	<ul><li>SCLA25TQC-R609LP</li><li>SCLA26AC12-R920LP1</li></ul>
Physical Stats		3U	■ <u>SC835TQC-R1K03B</u>
Form Factor	■ EATX		
Dimensions	■ 12" x 13.05" (30.5cm x 33.1cm)	Server(s) (with H12	2DSi-N6)
Dimensions	12 x 10.00 (00.0011 x 00.1011)	Model(s)	■ AS -2024S-TR
Processor/Chipset			
CPU	■ Dual AMD EPYC™ 7003/7002	System BIOS	
	Series Processors (The latest AMD EPYC™ 7003	BIOS Type	■ AMI 256Mb SPI Flash EEPROM
	Series Processor with AMD 3D V- Cache™ Technology requires BIOS version 2.3 or newer)  ■ Socket SP3	BIOS Features	<ul><li>Plug and Play (PnP)</li><li>DMI 2.3</li><li>PCI 2.2</li><li>ACPI 6.2</li></ul>
Cores	■ Up to 64 Cores		■ USB Keyboard Support ■ SMBIOS 3.1.1
Chipset	■ System on Chip		<u> </u>
		Management	
Capacity Sup	<ul> <li>16 DIMM slots</li> <li>Supports up to 4TB Registered ECC DDR4 3200MHz SDRAM</li> <li>8-channel memory bus</li> </ul>	Software	■ Super Doctor 5 ■ Watch Dog ■ NMI ■ SUM ■ IPMI 2.0, KVM with dedicated LAN
	<ul> <li>For Dual CPUs: Recommended that memory be populated equally in adjacent memory banks</li> </ul>	Power Configurations	<ul> <li>ACPI Power Management</li> <li>Power-on mode control for AC power loss recovery</li> </ul>
Memory Type	■ DDR4 3200 MHz Registered ECC, 288-pin gold-plated DIMMs	DC Hoolth Monitor	in a
DIMM Sizes	8GB, 16GB, 32GB, 64GB, 128GB, 256GB	PC Health Monitor	<ul><li>Monitors CPU Core Voltages, +1.5V,</li></ul>
Memory Voltage	■ 1.2V		+1.8V, +12V, +5V, +5V standby  CPU switching voltage regulator
Error Detection	<ul> <li>Corrects single-bit errors</li> <li>Detects double-bit errors (using ECC</li> </ul>	FAN	VBAT  Up to 8 fan status tachometer
On-Board Devices	memory)  SATA3 (6 Gbps)		<ul> <li>monitoring</li> <li>Up to 8x 4-pin fan headers</li> <li>Status monitor for speed control</li> <li>Pulse Width Modulated (PWM) fan connectors</li> </ul>
ІРМІ	<ul> <li>Support for Intelligent Platform</li> <li>Management Interface v. 2.0</li> <li>IPMI 2.0 with virtual media over LAN and KVM-over-LAN support</li> <li>ASPEED AST2600 BMC</li> </ul>	Temperature	<ul> <li>Monitoring for CPU and chassis environment</li> <li>CPU Thermal Trip Support</li> <li>Thermal control for 8x Fan connectors</li> <li>I²C Temperature Sensing Logic</li> </ul>
Network Controllers	<ul> <li>Dual LAN via Broadcom BCM5720L</li> <li>Gigabit Ethernet Controller</li> </ul>	LED	■ CPU / System Overheat LED
VGA	■ ASPEED AST2600 BMC	Other Features	■ Chassis Intrusion Detection
			<ul> <li>Chassis Intrusion Header</li> </ul>
Input / Output	■ 10 SATA3 (6 Gbps) ports	Operating Environ	ment / Compliance
LAN	<ul> <li>2x 1GbE LAN ports</li> <li>1 RJ45 Dedicated IPMI LAN port</li> </ul>	Environmental Specifications	■ Operating Temperature: 10°C to 35°C (50°F to 95°F)
USB	2 USB 2.0 ports (rear) 4 USB 3.0 ports (2 rear, 2 headers)		<ul> <li>Non-operating Temperature:         <ul> <li>-40°C to 70°C (-40°F to 158°F)</li> </ul> </li> <li>Operating Relative Humidity:</li> </ul>
VGA	■ 1 VGA port		8% to 90% (non-condensing)
Others	1 COM port (rear) 2 SATA DOM power connectors		<ul> <li>Non-operating Relative Humidity: 5% to 95% (non-condensing)</li> </ul>

■ TPM 2.0 header

2 SATA DOM power connectors
4 PCI-E 4.0 NVMe x4 internal ports

### **Expansion Slots**

PCI-Express	<ul><li>3 PCI-E 4.0 x16 slots</li><li>3 PCI-E 4.0 x8 slots</li></ul>
M.2	<ul><li>Interface: 1 PCI-E 4.0 x4</li><li>Form Factor: 2280, 22110</li><li>Key: M-key</li></ul>

# **Parts List**

#### **Bulk Pack List**

	Part Number	Qty	Description
Motherboard	MBD-H12DSi-N6-B	1	H12DSi-N6 Motherboard
I/O Shield	MCP-260-00042-0N	1	STD I/O SHIELD
I/O Cables	CBL-0044L	2	57.5CM SATA FLAT S-S PBF

#### **Retail Pack List**

	Part Number	Qty	Description
Motherboard	MBD-H12DSi-N6-O	1	H12DSi-N6 Motherboard
I/O Shield	MCP-260-00042-0N	1	STD I/O SHIELD
I/O Cables	CBL-0044L	4	57.5CM SATA FLAT S-S PBF

### **Optional Parts List**

	Part Number	Qty	Description
TPM security module	AOM-TPM-9655V	-	TPM 1.2 module with Infineon 9655, RoHS/REACH,PBF;
	AOM-TPM-9665V	-	TPM 2.0 module with Infineon 9665, RoHS/REACH,PBF;